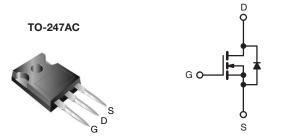


### **Power MOSFET**

PRODUCT SUMMARY						
V <sub>DS</sub> (V)	60	600				
R <sub>DS(on)</sub> (Ω)	V <sub>GS</sub> = 10 V	0.27				
Q <sub>g</sub> (Max.) (nC)	15	150				
Q <sub>gs</sub> (nC)	46	46				
Q <sub>gd</sub> (nC)	64					
Configuration	Sing	Single				



#### N-Channel MOSFET

#### **FEATURES**

• Superfast Body Diode Eliminates the Need for External Diodes in ZVS Applications



 Lower Gate Charge Results in Simple Drive RoHS Requirements

- Enhanced dV/dt Capabilities Offer Improved Ruggedness
- Higher Gate Voltage Threshold Offers Improved Noise **Immunity**
- Compliant to RoHS Directive 2002/95/EC

#### **APPLICATIONS**

- Zero Voltage Switching SMPS
- Telecom and Server Power Supplies
- Uninterruptible Power Supplies
- Motor Control Applications

ORDERING INFORMATION			
Package	TO-247AC		
Lead (Pb)-free	IRFP21N60LPbF		
	SiHFP21N60L-E3		
SnPb	IRFP21N60L		
	SiHFP21N60L		

<b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>C</sub> = 25 °C, unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			$V_{DS}$	600	V	
Gate-Source Voltage			$V_{GS}$	± 30	7 v	
Continuous Drain Current	\/ at 10 \/	T <sub>C</sub> = 25 °C	ı	21		
Continuous Drain Current	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 100 °C	l <sub>D</sub>	13	Α	
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	84		
Linear Derating Factor				2.6	W/°C	
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	420	mJ	
Repetitive Avalanche Current <sup>a</sup>			I <sub>AR</sub>	21	Α	
Repetitive Avalanche Energy <sup>a</sup>			E <sub>AR</sub>	33	mJ	
Maximum Power Dissipation $T_C = 25  ^{\circ}C$			$P_{D}$	330	W	
Peak Diode Recovery dV/dt <sup>c</sup>			dV/dt	16	V/ns	
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 150	°C	
Soldering Recommendations (Peak Temperature) for 10 s				300 <sup>d</sup>	7	
Mounting Torque	6-32 or M3 screw			10	lbf ⋅ in	
Mounting Torque				1.1	N⋅m	

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11). b. Starting T<sub>J</sub> = 25 °C, L = 1.9 mH, R<sub>g</sub> = 25  $\Omega$ , I<sub>AS</sub> = 21 A, dV/dt = 11 V/ns (see fig. 12a). c. I<sub>SD</sub>  $\leq$  21 A, dI/dt  $\leq$  530 A/µs, V<sub>DD</sub>  $\leq$  V<sub>DS</sub>, T<sub>J</sub>  $\leq$  150 °C.

- d. 1.6 mm from case.

<sup>\*</sup> Pb containing terminations are not RoHS compliant, exemptions may apply

# IRFP21N60L, SiHFP21N60L

# Vishay Siliconix



THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-	40		
Case-to-Sink, Flat, Greased Surface	R <sub>thCS</sub>	0.24	-	°C/W	
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	-	0.38		

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static							
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub>	= 0 V, I <sub>D</sub> = 250 μA	600	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	ce to 25 °C, I <sub>D</sub> = 1 mA	-	420	-	mV/°C
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> :	= V <sub>GS</sub> , I <sub>D</sub> = 250 μA	3.0	-	5.0	V
Gate-Source Leakage	I <sub>GSS</sub>		V <sub>GS</sub> = ± 30 V	-	-	± 100	nA
Zero Gate Voltage Drain Current	l	V <sub>DS</sub> =	$= 600 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	50	μΑ
Zero date voltage Drain Gurrent	I <sub>DSS</sub>	V <sub>DS</sub> = 480 \	/, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C	-	-	2.0	mA
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	$I_D = 13 A^b$	-	0.27	0.32	Ω
Forward Transconductance	9 <sub>fs</sub>	$V_{DS}$	= 50 V, I <sub>D</sub> = 13 A	11	-	-	S
Dynamic							
Input Capacitance	C <sub>iss</sub>		$V_{GS} = 0 V$ ,	-	4000	-	
Output Capacitance	$C_{oss}$		$V_{DS} = 25 V,$	-	340	-	
Reverse Transfer Capacitance	$C_{rss}$	f = 1	.0 MHz, see fig. 5	-	29	-	pF
Effective Output Capacitance	C <sub>oss</sub> eff.	V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 0 V to 480 V <sup>c</sup>		-	170	-	- 1
Effective Output Capacitance (Energy Related)	C <sub>oss</sub> eff. (ER)			-	130	-	
Total Gate Charge	$Q_g$		1 04 4 1/ 400 1/	-	-	150	
Gate-Source Charge	$Q_{gs}$	$V_{GS} = 10 \text{ V}$ $I_D = 21 \text{ A, } V_{DS} = 480 \text{ V}$ see fig. 7 and 15 <sup>b</sup>		-	-	46	nC
Gate-Drain Charge	$Q_{gd}$			-	-	64	
Gate Resistance	$R_g$	f = 1 MHz, open drain		-	0.63	-	Ω
Turn-On Delay Time	t <sub>d(on)</sub>	.,	000 \ / \ 01 \ \		20	-	
Rise Time	t <sub>r</sub>	$V_{DD} = 300 \text{ V, } I_D = 21 \text{ A,}$ $R_g = 1.3 \Omega, V_{GS} = 10 \text{ V,}$ see fig. 11a and 11bb		-	58	-	ns
Turn-Off Delay Time	t <sub>d(off)</sub>			-	33	-	
Fall Time	t <sub>f</sub>			-	10	-	
<b>Drain-Source Body Diode Characteristic</b>	cs						
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbol showing the		-	-	21	_ A
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>	integral reverse p - n junction diode		-	-	84	A
Body Diode Voltage	$V_{SD}$	$T_J = 25$ °C, $I_S = 21$ A, $V_{GS} = 0$ V <sup>b</sup>		-	-	1.5	V
		T <sub>J</sub> = 25 °C, I <sub>F</sub> = 21 A		-	160	240	
Body Diode Reverse Recovery Time	t <sub>rr</sub>	$T_J = 125 ^{\circ}\text{C},  \text{dl/dt} = 100  \text{A/}\mu\text{s}^b$		-	400	610	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	$T_{J} = 25  ^{\circ}\text{C},  I_{F} = 21  \text{A},  V_{GS} = 0  \text{V}^{\text{b}}$			480	730	nC
Body Blode Neverse necovery Orlange	<b>∨</b> rr	$T_J = 125  ^{\circ}\text{C},  dI/dt = 100  \text{A/µs}^{\text{b}}$		-	1540	2310	110
Reverse Recovery Time	I <sub>RRM</sub>	T <sub>J</sub> = 25 °C		-	5.3	7.9	Α
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn-on time is negligible (turn-on is dominated by L <sub>S</sub> and L <sub>D</sub> )					

#### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width  $\leq 300~\mu s;$  duty cycle  $\leq 2~\%.$
- c.  $C_{oss}$  eff. is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising form 0 % to 80 %  $V_{DS}$ .  $C_{oss}$  eff. (ER) is a fixed capacitance that stores the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DS}$ .



### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

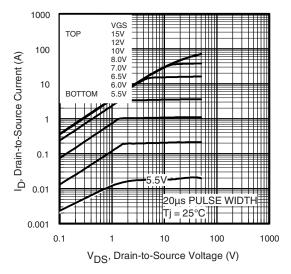


Fig. 1 - Typical Output Characteristics

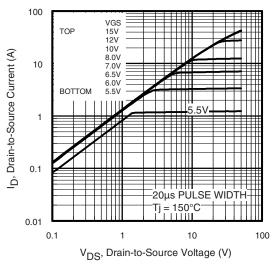


Fig. 2 - Typical Output Characteristics

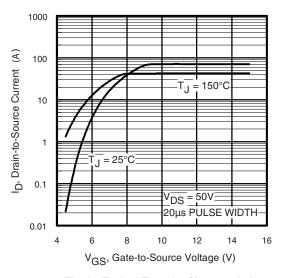


Fig. 3 - Typical Transfer Characteristics

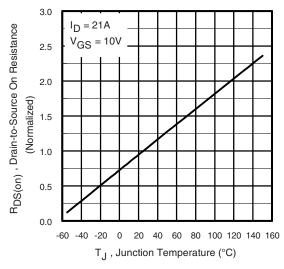


Fig. 4 - Normalized On-Resistance vs. Temperature



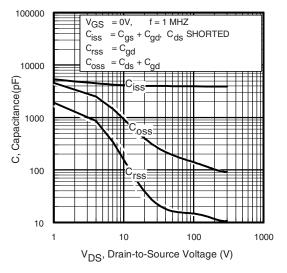


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

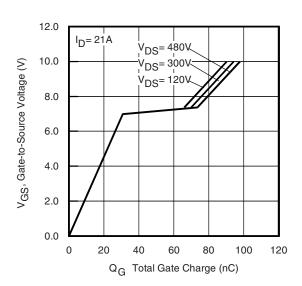


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

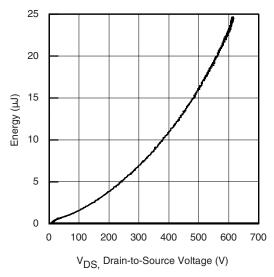


Fig. 6 - Typical Output Capacitance Stored Energy vs. V<sub>DS</sub>

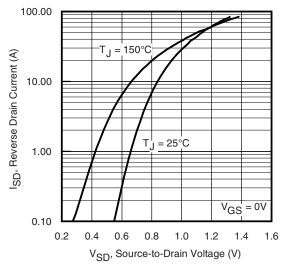
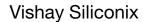


Fig. 8 - Typical Source-Drain Diode Forward Voltage

 $\mathsf{R}_\mathsf{D}$ 

D.U.T.



-<sup>+</sup>V<sub>DD</sub>



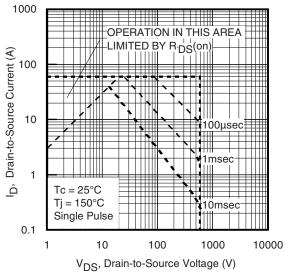
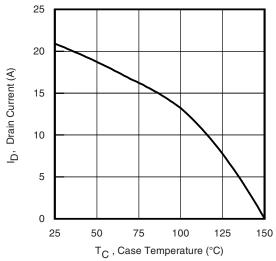


Fig. 11a - Switching Time Test Circuit

V<sub>DS</sub>

‡ 10 V Pulse width ≤ 1 μs

Fig. 9 - Maximum Safe Operating Area



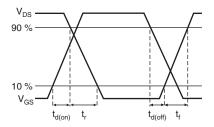


Fig. 11b - Switching Time Waveforms

Fig. 10 - Maximum Drain Current vs. Case Temperature

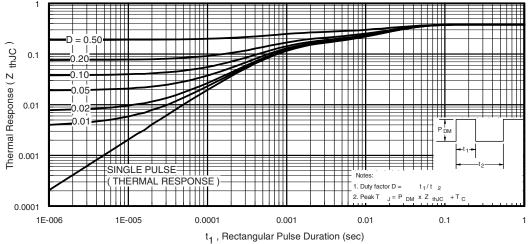


Fig. 12 - Maximum Effective Transient Thermal Impedance, Junction-to-Case



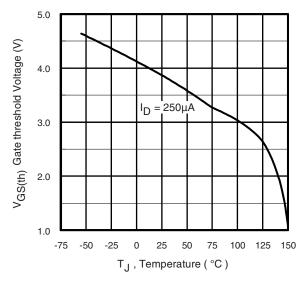


Fig. 13 - Threshold Voltage vs. Temperature

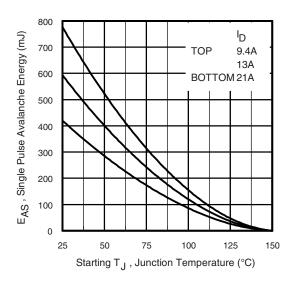


Fig. 14a - Maximum Avalanche Energy vs. Drain Current

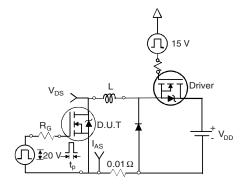


Fig. 14b - Unclamped Inductive Test Circuit

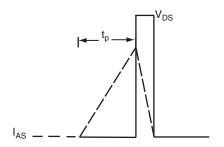


Fig. 14c - Unclamped Inductive Waveforms

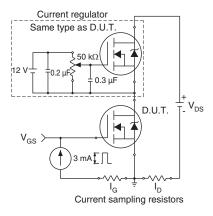


Fig. 15a - Gate Charge Test Circuit

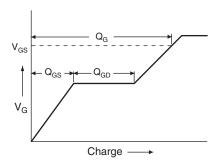
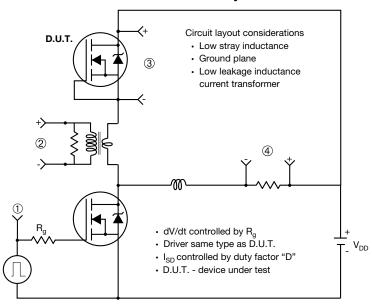


Fig. 15b - Basic Gate Charge Waveform

#### Peak Diode Recovery dV/dt Test Circuit



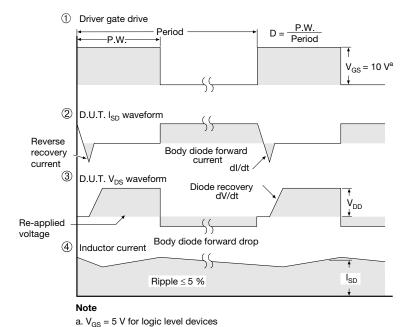
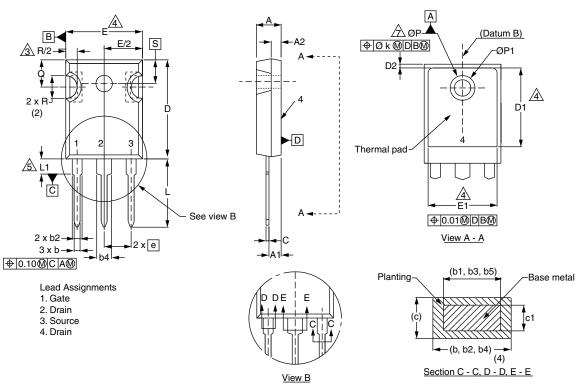


Fig. 16 - For N-Channel

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# **TO-247AC (High Voltage)**



	MILLIMETERS		INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
Α	4.58	5.31	0.180	0.209
A1	2.21	2.59	0.087	0.102
A2	1.17	2.49	0.046	0.098
b	0.99	1.40	0.039	0.055
b1	0.99	1.35	0.039	0.053
b2	1.53	2.39	0.060	0.094
b3	1.65	2.37	0.065	0.093
b4	2.42	3.43	0.095	0.135
b5	2.59	3.38	0.102	0.133
С	0.38	0.86	0.015	0.034
c1	0.38	0.76	0.015	0.030
D	19.71	20.82	0.776	0.820
D1	13.08	-	0.515	-

	MILLIMETERS		INC	HES	
DIM.	MIN.	MAX.	MIN.	MAX.	
D2	0.51	1.30	0.020	0.051	
E	15.29	15.87	0.602	0.625	
E1	13.72	ı	0.540	ı	
е	5.46	BSC	0.215 BSC		
Øk	0.2	0.254		0.010	
L	14.20	16.25	0.559	0.640	
L1	3.71	4.29	0.146	0.169	
N	7.62 BSC		0.300 BSC		
ØΡ	3.51	3.66	0.138	0.144	
Ø P1	-	7.39	-	0.291	
Q	5.31	5.69	0.209	0.224	
R	4.52	5.49	0.178	0.216	
S	5.51 BSC		0.217 BSC		
0.217 800					

ECN: X13-0103-Rev. D, 01-Jul-13

DWG: 5971

### **Notes**

- 1. Dimensioning and tolerancing per ASME Y14.5M-1994.
- 2. Contour of slot optional.
- 3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body.
- 4. Thermal pad contour optional with dimensions D1 and E1.
  5. Lead finish uncontrolled in L1.
- 6. Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154").
- 7. Outline conforms to JEDEC outline TO-247 with exception of dimension c.
- 8. Xian and Mingxin actually photo.





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Vishay

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